Attorney Docket No. 6199.0036-00

BOC Docket No. M00A422

## IN THE CLAIMS:

This listing of claims will replace all prior versions and listings of claims in the application.

1. (Currently Amended) A system for use with a plating cell configured to plate objects in a plating process wherein at least one byproduct is created in a plating

substance used in the plating cell, the system comprising:

a purification system configured to remove at least a portion of the at least one

byproduct from the plating substance, wherein the purification system comprises at

least

a first processing vessel,

a second processing vessel, and

a flow path providing flow from the first processing vessel to the second

processing vessel, wherein the flow path is configured such that the flow from the first

vessel to the second vessel is caused by gravity,

wherein at least one of the first processing vessel and the second

processing vessel is configured to remove at least a portion of the at least one

byproduct from the used plating substance.

2. (Original) The system according to claim 1, wherein the first processing

vessel comprises a reacting vessel configured to remove said at least a portion of the at

least one byproduct.

BOC Docket No. M00A422

3. (Original) The system according to claim 2, wherein the reacting vessel is

configured to supply at least one gas in the reacting vessel to react with the at least one

byproduct.

4. (Original) The system according to claim 3, wherein the gas comprises

ozone.

5. (Original) The system according to claim 3, wherein the reacting vessel is

configured to supply ultraviolet light in the reacting vessel.

6. (Original) The system according to claim 3, wherein the second

processing vessel is a degassing vessel configured to remove gas in the plating

substance.

7. (Original) The system according to claim 6, wherein the degassing vessel

is configured to supply at least one second gas to facilitate degassing of the plating

substance.

8. (Original) The system according to claim 7, wherein the second gas

comprises nitrogen.

9. (Original) The system according to claim 1, wherein the first processing

vessel includes an inlet near its top and an outlet near its bottom, wherein the second

Attorney Docket No. 6199.0036-00

BOC Docket No. M00A422

processing vessel includes an inlet near its top, and wherein the inlet of the second

processing vessel is lower than the inlet of the first processing vessel.

10. (Original) The system according to claim 9, wherein the inlet of the

second processing vessel ranges from about .5 inches to about 10 inches lower than

the inlet of the first processing vessel.

11. (Original) The system according to claim 1, wherein the purification

system includes a third processing vessel interposed between the first processing

vessel and the second processing vessel.

12. (Original) The system according to claim 11, wherein each of the first and

third processing vessels comprises a reacting vessel configured to remove said at least

a portion of the at least one byproduct from the plating substance.

13. (Original) The system according to claim 12, wherein the reacting vessel

of at least one of the first and third processing vessels is configured to supply at least

one gas to react with the at least one byproduct.

14. (Original) The system according to claim 13, wherein the gas comprises

ozone.

BOC Docket No. M00A422

15. (Original) The system according to claim 13, wherein at least one of the

reacting vessels is configured to supply ultraviolet light to increase the reaction between

the at least one byproduct and the gas.

16. (Original) The system according to claim 13, wherein the second

processing vessel is a degassing vessel configured to remove gas in the plating

substance.

17. (Original) The system according to claim 16, wherein the degassing

vessel is configured to supply at least one second gas to facilitate degassing of the

plating substance.

18. (Original) The system according to claim 17, wherein the second gas

comprises nitrogen.

19. (Original) The system according to claim 11, wherein each of the first and

third processing vessels includes an inlet near its top and an outlet near its bottom,

wherein the second processing vessel includes an inlet near its top, and wherein the

inlet of the second processing vessel is lower than the inlets of the first and third

processing vessels.

20. (Original) The system according to claim 19, wherein the inlets of the first

and third processing vessels are at substantially the same height.

Attorney Docket No. 6199.0036-00

BOC Docket No. M00A422

21. (Original) The system according to claim 20, wherein the inlet of the

second processing vessel ranges from about .5 inches to about 10 inches lower than

the inlets of the first and third processing vessels.

22. (Original) The system according to claim 1, wherein the first and second

processing vessels are operated at atmospheric pressure.

23. (Original) A system for use with a plating cell configured to plate objects

in a plating process wherein at least one byproduct is created in a plating substance

used in the plating cell, the system being configured to withdraw at least a portion of the

plating substance used in the plating cell, to remove at least a portion of the at least one

byproduct, and to return at least a portion of the plating substance to the plating cell, the

system comprising:

a tank for containing the plating substance used in the plating cell; and

a purification system according to claim 1.

24. (Original) The system according to claim 23, further comprising a pump

for withdrawing at least a portion of the plating substance from the tank.

25. (Original) The system according to claim 23, further comprising a return

pump for returning at least a portion of the plating substance to the tank.

BOC Docket No. M00A422

26. (Original) The system according to claim 25, wherein the purification

system includes a level detector associated with the second processing vessel and

wherein the return pump is controlled based on a level detected by the level detector.

27. (Original) The system according to claim 23, wherein the purification

system includes a third processing vessel interposed between the first and second

processing vessels.

28. (Original) The system according to claim 27, wherein each of the first and

third processing vessels comprises a reacting vessel configured to remove said at least

a portion of the at least one byproduct from the plating substance.

29. (Original) The system according to claim 28, wherein the reacting vessel

of at least one of the first and third processing vessels is configured to supply at least

one gas to react with the at least one byproduct.

30. (Original) The system according to claim 29, wherein the gas comprises

ozone.

31. (Original) The system according to claim 29, wherein at least one of the

reacting vessels is configured to supply ultraviolet light to react with the at least one

byproduct and the gas.

BOC Docket No. M00A422

32. (Original) The system according to claim 29, wherein the second

processing vessel is a degassing vessel configured to remove gas in the plating

substance.

33. (Original) The system according to claim 32, wherein the degassing

vessel is configured to supply at least one second gas to facilitate degassing of the

plating substance.

34. (Original) The system according to claim 33, wherein the second gas

comprises nitrogen.

35. (Original) The system according to claim 28, wherein each of the first and

third processing vessels includes an inlet near its top and an outlet near its bottom,

wherein the second processing vessel includes an inlet near its top, and wherein the

inlet of the second processing vessel is lower than the inlets of the first and third

processing vessels.

36. (Original) The system according to claim 35, wherein the inlets of the first

and third processing vessels are at substantially the same height.

37. (Original) The system according to claim 36, wherein the inlet of the

second processing vessel ranges from about .5 inches to about 10 inches lower than

the inlets of the first and third processing vessels.

BOC Docket No. M00A422

38. (Original) A system for use with a plating cell configured to plate objects

in a plating process wherein at least one byproduct is created in a plating substance

used in the plating cell, the system comprising:

a purification system configured to remove at least a portion of the at least one

byproduct from the plating substance, wherein the purification system comprises at

least

a first processing vessel, wherein the first processing vessel includes an

inlet near its top and an outlet near its bottom,

a second processing vessel, wherein the second processing vessel

includes an inlet near its top, and wherein the second processing vessel is arranged

such that the inlet of the second processing vessel is lower than the inlet of the first

processing vessel, and

a flow path providing flow from the outlet of the first processing vessel to

the inlet of the second processing vessel.

39. (Original) The system according to claim 38, wherein the first processing

vessel comprises a reacting vessel configured to remove said at least a portion of the at

least one byproduct, wherein the reacting vessel is configured to supply at least one gas

in the reacting vessel to react with the at least one byproduct.

40. (Original) The system according to claim 39, wherein the reacting vessel

is configured to supply ultraviolet light in the reacting vessel.

Application No.: 09/944,370 Attorney Docket No. 6199.0036-00 BOC Docket No. M00A422

41. (Original) The system according to claim 39, wherein the second processing vessel comprises a degassing vessel configured to remove gas in the plating substance.

- 42. (Original) The system according to claim 38, wherein the inlet of the second processing vessel ranges from about .5 inches to about 10 inches lower than the inlet of the first processing vessel.
- 43. (Original) The system according to claim 38, wherein the purification system includes a third processing vessel interposed between the first processing vessel and the second processing vessel, wherein the third processing vessel includes an inlet near its top and an outlet near its bottom, wherein the outlet of the first processing vessel is flow connected to the inlet of the third processing vessel, and the outlet of the third processing vessel is flow connected to the inlet of the second processing vessel.
- 44. (Original) The system according to claim 43, wherein at least one of the first and third processing vessels comprises a reacting vessel configured to supply at least one gas to react with the at least one byproduct.
- 45. (Original) The system according to claim 44, wherein the reacting vessel is configured to supply ultraviolet light.

BOC Docket No. M00A422

46. (Original) The system according to claim 45, wherein the second

processing vessel comprises a degassing vessel configured to remove gas in the

plating substance.

47. (Original) The system according to claim 46, wherein the inlet of the

second processing vessel ranges from about .5 inches to about 10 inches lower than

the inlets of the first and third processing vessels.

48. (Original) A system for use with a plating cell configured to plate objects

in a plating process wherein at least one byproduct is created in a plating substance

used in the plating cell, the system being configured to withdraw at least a portion of the

plating substance used in the plating cell, to remove at least a portion of the at least one

byproduct, and to return at least a portion of the plating substance to the plating cell, the

system comprising:

a tank for containing the plating substance used in the plating cell; and

a purification system according to claim 38.

49. (Original) The system according to claim 48, further comprising a pump

for withdrawing at least a portion of the plating substance from the tank.

50. (Original) The system according to claim 48, further comprising a return

pump for returning at least a portion of the plating substance to the tank.

BOC Docket No. M00A422

51. (Original) The system according to claim 50, wherein the purification

system includes a level detector associated with the second processing vessel and

wherein the return pump is controlled based on a level detected by the level detector.

52. (Original) The system according to claim 48, wherein the purification

system includes a third processing vessel interposed between the first and second

processing vessels, wherein the third processing vessel includes an inlet near its top

and an outlet near its bottom, wherein the outlet of the first processing vessel is flow

connected to the inlet of the third processing vessel and the outlet of the third

processing vessel is flow connected to the inlet of the second processing vessel.

53. (Original) A method for removing at least a portion of at least one

byproduct from a plating substance used in a plating cell, the method comprising:

flowing a used plating substance from the plating cell to a purification system

configured to remove at least a portion of at least one byproduct from the used plating

substance, wherein the purification system comprises at least

a first processing vessel,

a second processing vessel, and

a flow path providing flow from the first processing vessel to the second

processing vessel, wherein the flow path is configured such that the flow from the first

processing vessel to the second processing vessel is caused by gravity;

Attorney Docket No. **6199.0036-00** 

BOC Docket No. M00A422

passing the used plating substance from the first processing vessel to the second

processing vessel by gravity; and

removing at least a portion of the at least one byproduct from the used plating

substance in at least one of the first and second processing vessels.

54. (Original) The method according to claim 53, wherein the first processing

vessel comprises a reacting vessel configured to remove said at least a portion of the at

least one byproduct, and wherein the method further comprises supplying at least one

gas within the reacting vessel such that said at least a portion of the at least one

byproduct reacts with the gas.

55. (Original) The method according to claim 54, further comprises applying

ultraviolet light to the used plating substance within the reacting vessel to increase the

amount of reaction between the gas and said at least a portion of the at least one

byproduct.

56. (Original) The method according to claim 54, wherein the second

processing vessel comprises a degassing vessel configured to remove gas in the used

plating substance, and the method further comprises supplying at least one second gas

to the used plating substance within the degassing vessel such that the second gas

facilitates degassing of the used plating substance.

Application No.: 09/944,370 Attorney Docket No. 6199.0036-00 BOC Docket No. M00A422

57. (Original) The method according to claim 53, wherein the first processing vessel includes an inlet near its top and an outlet near its bottom, wherein the second processing vessel includes an inlet near its top, wherein the inlet of the second processing vessel is lower than the inlet of the first processing vessel, and wherein the passing comprises passing the used plating substance from the outlet of the first processing vessel to the inlet of the second processing vessel by gravity.

- 58. (Original) The method according to claim 53, wherein the flowing comprises conveying the used plating substance from a storage tank to the purification system.
- 59. (Original) The method according to claim 58, wherein the conveying comprises pumping the used plating substance from the storage tank to the purification system.
- 60. (Original) The method according to claim 58, further comprising pumping the used plating substance from the purification system to the tank with a return pump.
- 61. (Original) The method according to claim 60, further comprising detecting the level of the used plating substance in the second processing vessel and adjusting the return pump based on the detected level.

BOC Docket No. M00A422

62. (Original) The method according to claim 61, wherein the adjusting

maintains the used plating substance at a predetermined level in the second processing

vessel.

63. (Original) The method according to claim 53, wherein the purification

system includes a third processing vessel interposed between the first and second

processing vessels, and wherein the passing includes passing the used plating

substance through the third processing vessel.

64. (Original) The system according to claim 24, wherein the purification

system includes a level detector associated with the second processing vessel and

wherein the pump for withdrawing at least a portion of the plating substance is

controlled based on a level detected by the level detector.

65. (Original) The system according to claim 49, wherein the purification

system includes a level detector associated with the second processing vessel and

wherein the pump for withdrawing at least a portion of the plating substance is

controlled based on a level detected by the level detector.

66. (Original) The method according to claim 60, further comprising detecting

the level of the used plating substance in the second processing vessel and adjusting

the pumping based on the detected level.

BOC Docket No. M00A422

67. (Previously Presented) The system according to claim 1, wherein the first

processing vessel includes an inlet near its top and an outlet near its bottom, wherein

the second processing vessel includes an inlet near its top, and wherein the inlet of the

second processing vessel is higher than the outlet of the first processing vessel.

68. (Previously Presented) The system according to claim 38, wherein the

inlet of the second processing vessel is higher than the outlet of the first processing

vessel.

69. (Previously Presented) The method according to claim 53, wherein the

first processing vessel includes an inlet near its top and an outlet near its bottom,

wherein the second processing vessel includes an inlet near its top, and wherein the

inlet of the second processing vessel is higher than the outlet of the first processing

vessel.

70. (Previously Presented) The system according to claim 1, wherein the first

processing vessel is configured to hold a first level of substance, wherein the second

processing vessel is configured to hold a second level of substance, and wherein the

second level is lower than or equal to the first level.

71. (Previously Presented) The system according to claim 38, wherein the

first processing vessel is configured to hold a first level of substance, wherein the

Attorney Docket No. 6199.0036-00

BOC Docket No. M00A422

second processing vessel is configured to hold a second level of substance, and wherein the second level is lower than or equal to the first level.

- 72. (Previously Presented) The method according to claim 53, further comprising establishing a first level of substance in the first processing vessel and establishing a second level of substance in the second processing vessel, wherein the second level is lower than or equal to the first level.
- 73. (New) The system according to claim 38, wherein at least one of the first processing vessel and the second processing vessel is configured to remove at least a portion of the at least one byproduct from the used plating substance.